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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	56
Program Memory Size	60KB (60K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s08gb60acfuer

1.2.2 Features of MC9S08GBxxA/GTxxA Series of MCUs

- On-chip in-circuit programmable flash memory:
  - Fully read/write functional across voltage and temperature ranges
  - Block protection and security options
  - (see Table 1-1 for device-specific information)
- On-chip random-access memory (RAM) (see Table 1-1 for device specific information)
- 8-channel, 10-bit analog-to-digital converter (ATD)
- Two serial communications interface modules (SCI)
- Serial peripheral interface module (SPI)
- Multiple clock source options:
  - Internally generated clock with ±0.2% trimming resolution and ±0.5% deviation across voltage
  - Crystal
  - Resonator
  - External clock
- Inter-integrated circuit bus module to operate up to 100 kbps (IIC)
- One 3-channel and one 5-channel 16-bit timer/pulse width modulator (TPM) modules with selectable input capture, output compare, and edge-aligned PWM capability on each channel. Each timer module may be configured for buffered, centered PWM (CPWM) on all channels (TPMx).
- 8-pin keyboard interrupt module (KBI)
- 16 high-current pins (limited by package dissipation)
- Software selectable pullups on ports when used as input. Selection is on an individual port bit basis. During output mode, pullups are disengaged.
- Internal pullup on $\overline{\text{RESET}}$ and IRQ pin to reduce customer system cost
- Up to 56 general-purpose input/output (I/O) pins, depending on package selection
- 64-pin low-profile quad flat package (LQFP) — MC9S08GBxxA
- 48-pin quad flat package, no lead (QFN) — MC9S08GTxxA
- 44-pin quad flat package (QFP) — MC9S08GTxxA
- 42-pin skinny dual in-line package (SDIP) — MC9S08GTxxA

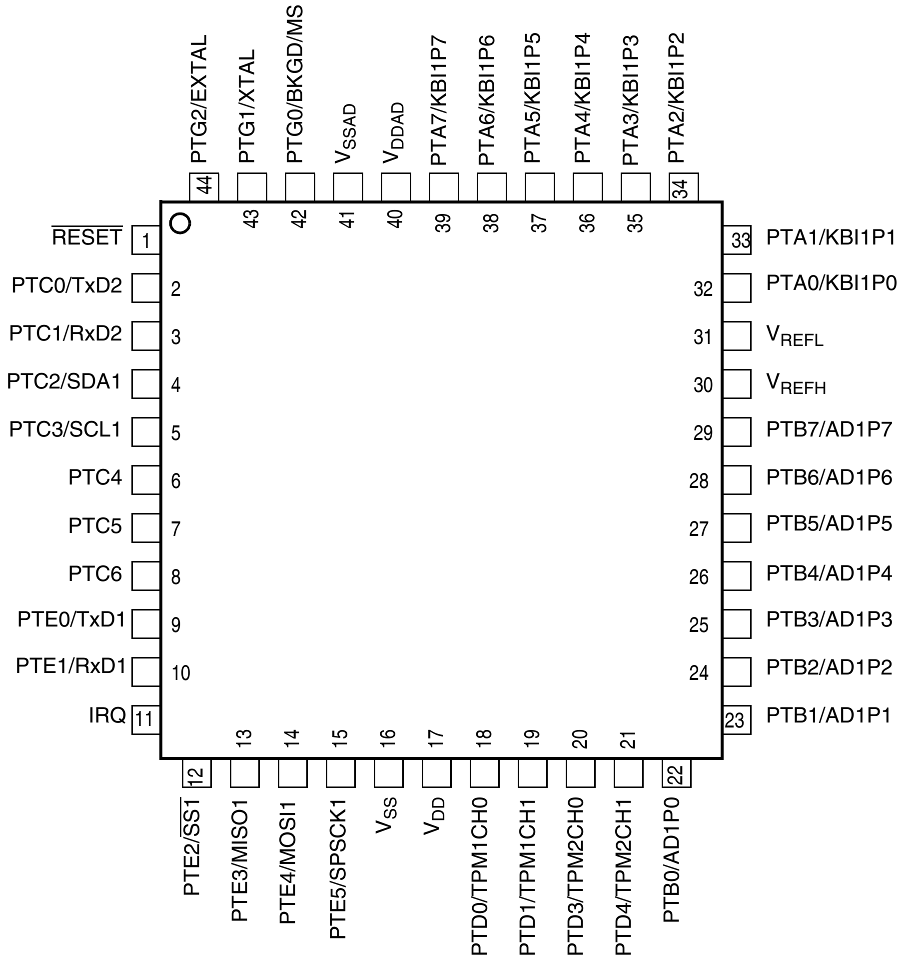
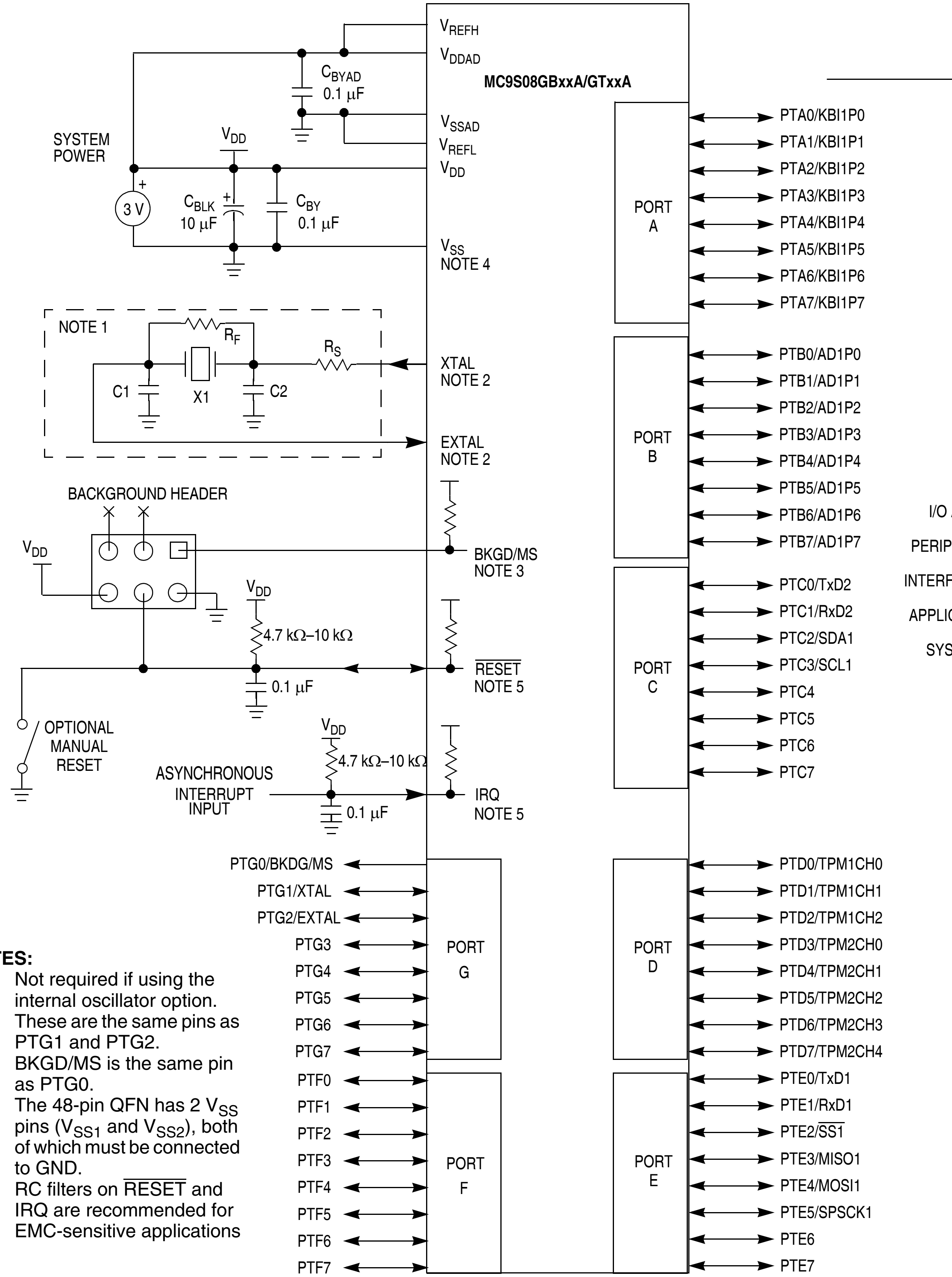


Figure 2-3. MC9S08GTxxA in 44-Pin QFP Package



NOTES:

1. Not required if using the internal oscillator option.
2. These are the same pins as PTG1 and PTG2.
3. BKGD/MS is the same pin as PTG0.
4. The 48-pin QFN has 2 V_{SS} pins (V_{SS1} and V_{SS2}), both of which must be connected to GND.
5. RC filters on $\overline{\text{RESET}}$ and IRQ are recommended for EMC-sensitive applications

Figure 2-5. Basic System Connections

	7	6	5	4	3	2	1	0
R	DIVLD	PRDIV8	DIV5	DIV4	DIV3	DIV2	DIV1	DIV0
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 4-4. Flash Clock Divider Register (FCDIV)

Table 4-6. FCDIV Field Descriptions

Field	Description
7 DIVLD	**Divisor Loaded Status Flag** — When set, this read-only status flag indicates that the FCDIV register has been written since reset. Reset clears this bit and the first write to this register causes this bit to become set regardless of the data written. 0 FCDIV has not been written since reset; erase and program operations disabled for flash. 1 FCDIV has been written since reset; erase and program operations enabled for flash.
6 PRDIV8	**Prescale (Divide) Flash Clock by 8** 0 Clock input to the flash clock divider is the bus rate clock. 1 Clock input to the flash clock divider is the bus rate clock divided by 8.
5 DIV[5:0]	**Divisor for Flash Clock Divider** — The flash clock divider divides the bus rate clock (or the bus rate clock divided by 8 if PRDIV8 = 1) by the value in the 6-bit DIV5:DIV0 field plus one. The resulting frequency of the internal flash clock must fall within the range of 200 kHz to 150 kHz for proper flash operations. Program/erase timing pulses are one cycle of this internal flash clock, which corresponds to a range of 5 μs to 6.7 μs. The automated programming logic uses an integer number of these pulses to complete an erase or program operation. See Equation 4-1 and Equation 4-2. Table 4-7 shows the appropriate values for PRDIV8 and DIV5:DIV0 for selected bus frequencies.

$$\text{if PRDIV8} = 0 \text{ — } f_{FCLK} = f_{Bus} \div ([\text{DIV5:DIV0}] + 1) \qquad \textit{Eqn. 4-1}$$

$$\text{if PRDIV8} = 1 \text{ — } f_{FCLK} = f_{Bus} \div (8 \times ([\text{DIV5:DIV0}] + 1)) \qquad \textit{Eqn. 4-2}$$

Table 4-7. Flash Clock Divider Settings

f_{Bus}	PRDIV8 (Binary)	DIV5:DIV0 (Decimal)	f_{FCLK}	Program/Erase Timing Pulse (5 μs Min, 6.7 μs Max)
20 MHz	1	12	192.3 kHz	5.2 μs
10 MHz	0	49	200 kHz	5 μs
8 MHz	0	39	200 kHz	5 μs
4 MHz	0	19	200 kHz	5 μs
2 MHz	0	9	200 kHz	5 μs
1 MHz	0	4	200 kHz	5 μs
200 kHz	0	0	200 kHz	5 μs
150 kHz	0	0	150 kHz	6.7 μs

5.8.8 System Power Management Status and Control 2 Register (SPMSC2)

This register is used to report the status of the low voltage warning function, and to configure the stop mode behavior of the MCU.

	7	6	5	4	3	2	1	0
R	LVWF	0	LVDV	LVWV	PPDF	0	PDC	PPDC
W		LVWACK				PPDACK		
Power-on reset:	0(1)	0	0	0	0	0	0	0
LVD reset:	0(1)	0	U	U	0	0	0	0
Any other reset:	0(1)	0	U	U	0	0	0	0

= Unimplemented or Reserved   U = Unaffected by reset

1 LVWF will be set in the case when V_{Supply} transitions below the trip point or after reset and V_{Supply} is already below V_{LVW}.

Figure 5-10. System Power Management Status and Control 2 Register (SPMSC2)

Table 5-11. SPMSC2 Field Descriptions

Field	Description
7 LVWF	**Low-Voltage Warning Flag** — The LVWF bit indicates the low voltage warning status. 0 Low voltage warning **not** present. 1 Low voltage warning is present or was present.
6 LVWACK	**Low-Voltage Warning Acknowledge** — The LVWACK bit is the low-voltage warning acknowledge. Writing a 1 to LVWACK clears LVWF to 0 if a low voltage warning is not present.
5 LVDV	**Low-Voltage Detect Voltage Select** — The LVDV bit selects the LVD trip point voltage (V_{LVD}). 0 Low trip point selected ($V_{LVD} = V_{LVDL}$). 1 High trip point selected ($V_{LVD} = V_{LVDH}$).
4 LVWV	**Low-Voltage Warning Voltage Select** — The LVWV bit selects the LVW trip point voltage (V_{LVW}). 0 Low trip point selected ($V_{LVW} = V_{LVWL}$). 1 High trip point selected ($V_{LVW} = V_{LVWH}$).
3 PPDF	**Partial Power Down Flag** — The PPDF bit indicates that the MCU has exited the stop2 mode. 0 Not stop2 mode recovery. 1 Stop2 mode recovery.
2 PPDACK	**Partial Power Down Acknowledge** — Writing a 1 to PPDACK clears the PPDF bit.
1 PDC	**Power Down Control** — The write-once PDC bit controls entry into the power down (stop2 and stop1) modes. 0 Power down modes are disabled. 1 Power down modes are enabled.
0 PPDC	**Partial Power Down Control** — The write-once PPDC bit controls which power down mode, stop1 or stop2, is selected. 0 Stop1, full power down, mode enabled if PDC set. 1 Stop2, partial power down, mode enabled if PDC set.

	7	6	5	4	3	2	1	0
R W	PTCPE7	PTCPE6	PTCPE5	PTCPE4	PTCPE3	PTCPE2	PTCPE1	PTCPE0
Reset	0	0	0	0	0	0	0	0

Figure 6-18. Pullup Enable for Port C (PTCPE)

Table 6-10. PTCPE Field Descriptions

Field	Description
7:0 PTCPE[7:0]	**Pullup Enable for Port C Bits** — For port C pins that are inputs, these read/write control bits determine whether internal pullup devices are enabled. For port C pins that are configured as outputs, these bits are ignored and the internal pullup devices are disabled. 0 Internal pullup device disabled. 1 Internal pullup device enabled.

	7	6	5	4	3	2	1	0
R W	PTCSE7	PTCSE6	PTCSE5	PTCSE4	PTCSE3	PTCSE2	PTCSE1	PTCSE0
Reset	0	0	0	0	0	0	0	0

Figure 6-19. Slew Rate Control Enable for Port C (PTCSE)

Table 6-11. PTCSE Field Descriptions

Field	Description
7:0 PTCSE[7:0]	**Slew Rate Control Enable for Port C Bits** — For port C pins that are outputs, these read/write control bits determine whether the slew rate controlled outputs are enabled. For port B pins that are configured as inputs, these bits are ignored. 0 Slew rate control disabled. 1 Slew rate control enabled.

	7	6	5	4	3	2	1	0
R W	PTCDD7	PTCDD6	PTCDD5	PTCDD4	PTCDD3	PTCDD2	PTCDD1	PTCDD0
Reset	0	0	0	0	0	0	0	0

Figure 6-20. Data Direction for Port C (PTCDD)

Table 6-12. PTCDD Field Descriptions

Field	Description
7:0 PTCDD[7:0]	**Data Direction for Port C Bits** — These read/write bits control the direction of port C pins and what is read for PTCD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port C bit n and PTCD reads return the contents of PTCDn.

	7	6	5	4	3	2	1	0
R W	PTGSE7	PTGSE6	PTGSE5	PTGSE4	PTGSE3	PTGSE2	PTGSE1	PTGSE0
Reset	0	0	0	0	0	0	0	0

Figure 6-35. Slew Rate Control Enable for Port G (PTGSE)

Table 6-27. PTGSE Field Descriptions

Field	Description
7:0 PTGSE[7:0]	**Slew Rate Control Enable for Port G Bits** — For port G pins that are outputs, these read/write control bits determine whether the slew rate controlled outputs are enabled. For port G pins that are configured as inputs, these bits are ignored. 0 Slew rate control disabled. 1 Slew rate control enabled.

	7	6	5	4	3	2	1	0
R W	PTGDD7	PTGDD6	PTGDD5	PTGDD4	PTGDD3	PTGDD2	PTGDD1	PTGDD0
Reset	0	0	0	0	0	0	0	0

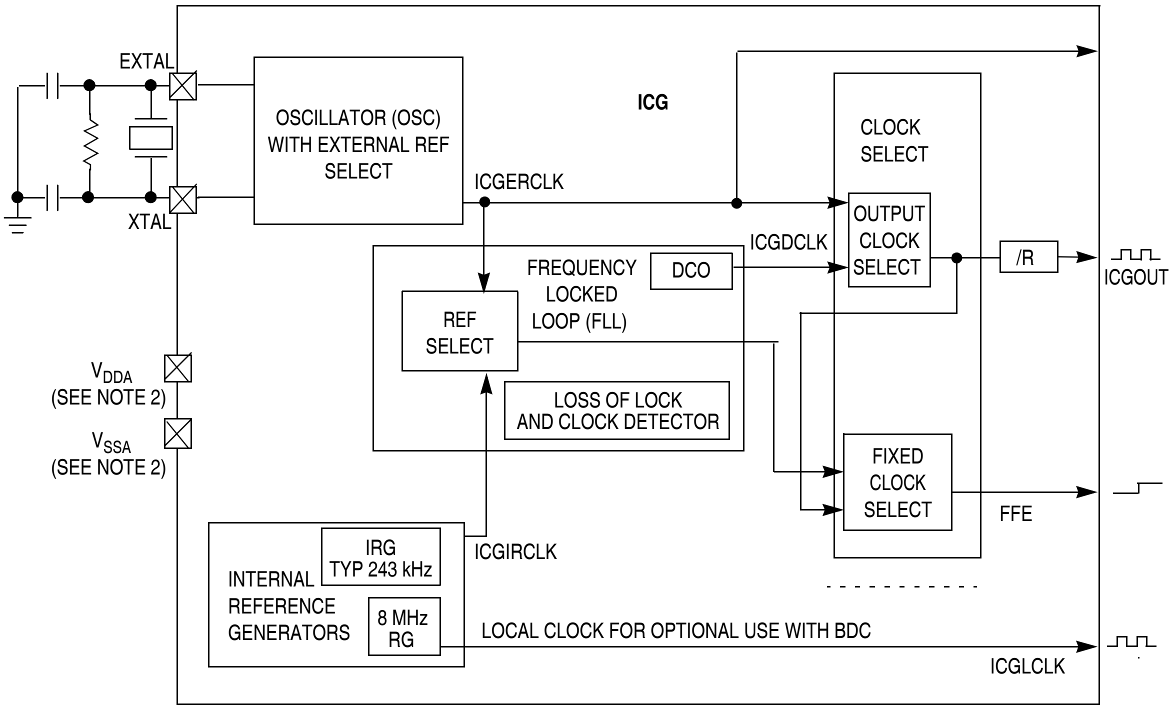
Figure 6-36. Data Direction for Port G (PTGDD)

Table 6-28. PTGDD Field Descriptions

Field	Description
7:0 PTGDD[7:0]	**Data Direction for Port G Bits** — These read/write bits control the direction of port G pins and what is read for PTGD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port G bit n and PTGD reads return the contents of PTGDn.

7.1 Introduction

Figure 7-3 is a top-level diagram that shows the functional organization of the internal clock generation (ICG) module. This section includes a general description and a feature list.



NOTES:
1. See Table 7-1 for specific use of ICGOUT, FFE, ICGLCLK, ICGERCLK
2. Not all HCS08 microcontrollers have unique supply pins for the ICG. See the device pin assignments in Chapter 2, "Pins and Connections for specifics.

Figure 7-3. ICG Block Diagram

The ICG provides multiple options for clock sources. This offers a user great flexibility when making choices between cost, precision, current draw, and performance. As seen in Figure 7-3, the ICG consists of four functional blocks. Each of these is briefly described here and then in more detail in a later section.

- **Oscillator block** — The oscillator block provides means for connecting an external crystal or resonator. Two frequency ranges are software selectable to allow optimal startup and stability. Alternatively, the oscillator block can be used to route an external square wave to the system clock. External sources can provide a very precise clock source. The oscillator is capable of being configured for low power mode or high amplitude mode as selected by HGO.
- **Internal reference generator** — The internal reference generator consists of two controlled clock sources. One is designed to be approximately 8 MHz and can be selected as a local clock for the background debug controller. The other internal reference clock source is typically 243 kHz and can be trimmed for finer accuracy via software when a precise timed event is input to the MCU. This provides a highly reliable, low-cost clock source.
- **Frequency-locked loop** — A frequency-locked loop (FLL) stage takes either the internal or external clock source and multiplies it to a higher frequency. Status bits provide information when the circuit has achieved lock and when it falls out of lock. Additionally, this block can monitor the external reference clock and signals whether the clock is valid or not.

7.5.4 ICG Status Register 2 (ICGS2)

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	DCOS
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 7-15. ICG Status Register 2 (ICGS2)

Table 7-9. ICGS2 Field Descriptions

Field	Description
0 DCOS	**DCO Clock Stable** — The DCOS bit is set when the DCO clock (ICG2DCLK) is stable, meaning the count error has not changed by more than n_{unlock} for two consecutive samples and the DCO clock is not static. This bit is used when exiting off state if CLKS = X1 to determine when to switch to the requested clock mode. It is also used in self-clocked mode to determine when to start monitoring the DCO clock. This bit is cleared upon entering the off state. 0 DCO clock is unstable. 1 DCO clock is stable.

7.5.5 ICG Filter Registers (ICGFLTU, ICGFLTL)

The filter registers show the filter value (FLT).

	7	6	5	4	3	2	1	0
R	0	0	0	0	FLT			
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 7-16. ICG Upper Filter Register (ICGFLTU)

Table 7-10. ICGFLTU Field Descriptions

Field	Description
3:0 FLT	**Filter Value** — The FLT bits indicate the current filter value, which controls the DCO frequency. The FLT bits are read only except when the CLKS bits are programmed to self-clocked mode (CLKS = 00). In self-clocked mode, any write to ICGFLTU updates the current 12-bit filter value. Writes to the ICGFLTU register will not affect FLT if a previous latch sequence is not complete.

8.2.3 Stack Pointer (SP)

This 16-bit address pointer register points at the next available location on the automatic last-in-first-out (LIFO) stack. The stack may be located anywhere in the 64-Kbyte address space that has RAM and can be any size up to the amount of available RAM. The stack is used to automatically save the return address for subroutine calls, the return address and CPU registers during interrupts, and for local variables. The AIS (add immediate to stack pointer) instruction adds an 8-bit signed immediate value to SP. This is most often used to allocate or deallocate space for local variables on the stack.

SP is forced to 0x00FF at reset for compatibility with the earlier M68HC05 Family. HCS08 programs normally change the value in SP to the address of the last location (highest address) in on-chip RAM during reset initialization to free up direct page RAM (from the end of the on-chip registers to 0x00FF).

The RSP (reset stack pointer) instruction was included for compatibility with the M68HC05 Family and is seldom used in new HCS08 programs because it only affects the low-order half of the stack pointer.

8.2.4 Program Counter (PC)

The program counter is a 16-bit register that contains the address of the next instruction or operand to be fetched.

During normal program execution, the program counter automatically increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, interrupt, and return operations load the program counter with an address other than that of the next sequential location. This is called a change-of-flow.

During reset, the program counter is loaded with the reset vector that is located at 0xFFFE and 0xFFFF. The vector stored there is the address of the first instruction that will be executed after exiting the reset state.

8.2.5 Condition Code Register (CCR)

The 8-bit condition code register contains the interrupt mask (I) and five flags that indicate the results of the instruction just executed. Bits 6 and 5 are set permanently to 1. The following paragraphs describe the functions of the condition code bits in general terms. For a more detailed explanation of how each instruction sets the CCR bits, refer to the *HCS08 Family Reference Manual, volume 1,* Freescale Semiconductor document order number HCS08RMv1.

8.4.5 BGND Instruction

The BGND instruction is new to the HCS08 compared to the M68HC08. BGND would not be used in normal user programs because it forces the CPU to stop processing user instructions and enter the active background mode. The only way to resume execution of the user program is through reset or by a host debug system issuing a GO, TRACE1, or TAGGO serial command through the background debug interface.

Software-based breakpoints can be set by replacing an opcode at the desired breakpoint address with the BGND opcode. When the program reaches this breakpoint address, the CPU is forced to active background mode rather than continuing the user program.

Table 8-3. Opcode Map (Sheet 2 of 2)

Bit-Manipulation		Branch	Read-Modify-Write					Control		Register/Memory					
						9E60 6 NEG 3 SP1							9ED0 5 SUB 4 SP2	9EE0 4 SUB 3 SP1	
						9E61 6 CBEQ 4 SP1							9ED1 5 CMP 4 SP2	9EE1 4 CMP 3 SP1	
													9ED2 5 SBC 4 SP2	9EE2 4 SBC 3 SP1	
						9E63 6 COM 3 SP1							9ED3 5 CPX 4 SP2	9EE3 4 CPX 3 SP1	9EF3 6 CPHX 3 SP1
						9E64 6 LSR 3 SP1							9ED4 5 AND 4 SP2	9EE4 4 AND 3 SP1	
													9ED5 5 BIT 4 SP2	9EE5 4 BIT 3 SP1	
						9E66 6 ROR 3 SP1							9ED6 5 LDA 4 SP2	9EE6 4 LDA 3 SP1	
						9E67 6 ASR 3 SP1							9ED7 5 STA 4 SP2	9EE7 4 STA 3 SP1	
						9E68 6 LSL 3 SP1							9ED8 5 EOR 4 SP2	9EE8 4 EOR 3 SP1	
						9E69 6 ROL 3 SP1							9ED9 5 ADC 4 SP2	9EE9 4 ADC 3 SP1	
						9E6A 6 DEC 3 SP1							9EDA 5 ORA 4 SP2	9EEA 4 ORA 3 SP1	
						9E6B 8 DBNZ 4 SP1							9EDB 5 ADD 4 SP2	9EEB 4 ADD 3 SP1	
						9E6C 6 INC 3 SP1									
						9E6D 5 TST 3 SP1									
										9EAE 5 LDHX 2 IX	9EBE 6 LDHX 4 IX2	9ECE 5 LDHX 3 IX1	9EDE 5 LDX 4 SP2	9EEE 4 LDX 3 SP1	9EFE 5 LDHX 3 SP1
						9E6F 6 CLR 3 SP1							9EDF 5 STX 4 SP2	9EEF 4 STX 3 SP1	9EFF 5 STHX 3 SP1

INH	**Inherent**	**REL**	**Relative**	**SP1**	**Stack Pointer, 8-Bit Offset**
IMM	**Immediate**	**IX**	**Indexed, No Offset**	**SP2**	**Stack Pointer, 16-Bit Offset**
DIR	**Direct**	**IX1**	**Indexed, 8-Bit Offset**	**IX+**	**Indexed, No Offset with Post Increment**
EXT	**Extended**	**IX2**	**Indexed, 16-Bit Offset**		
DD	**DIR to DIR**	**IMD**	**IMM to DIR**	**IX1+**	**Indexed, 1-Byte Offset with Post Increment**
IX+D	**IX+ to DIR**	**DIX+**	**DIR to IX+**		

Note: All Sheet 2 Opcodes are Preceded by the Page 2 Prebyte (9E)

Prebyte (9E) and Opcode in Hexadecimal	9E60 6	HCS08 Cycles
	NEG	Instruction Mnemonic
Number of Bytes	3 SP1	Addressing Mode

register (TPMxCnVH:TPMxCnVL). The polarity of this PWM signal is determined by the setting in the ELSnA control bit. Duty cycle cases of 0 percent and 100 percent are possible.

As Figure 10-3 shows, the output compare value in the TPM channel registers determines the pulse width (duty cycle) of the PWM signal. The time between the modulus overflow and the output compare is the pulse width. If ELSnA = 0, the counter overflow forces the PWM signal high and the output compare forces the PWM signal low. If ELSnA = 1, the counter overflow forces the PWM signal low and the output compare forces the PWM signal high.

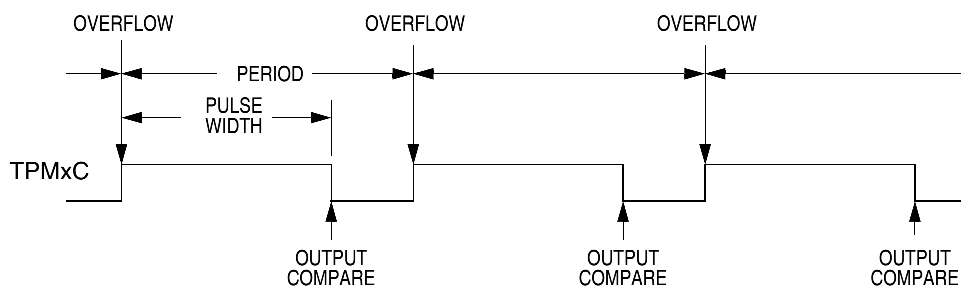


Figure 10-3. PWM Period and Pulse Width (ELSnA = 0)

When the channel value register is set to $0000, the duty cycle is 0 percent. By setting the timer channel value register (TPMxCnVH:TPMxCnVL) to a value greater than the modulus setting, 100 percent duty cycle can be achieved. This implies that the modulus setting must be less than $FFFF to get 100 percent duty cycle.

Because the HCS08 is a family of 8-bit MCUs, the settings in the timer channel registers are buffered to ensure coherent 16-bit updates and to avoid unexpected PWM pulse widths. Writes to either register, TPMxCnVH or TPMxCnVL, write to buffer registers. In edge-PWM mode, values are transferred to the corresponding timer channel registers only after both 8-bit bytes of a 16-bit register have been written and the value in the TPMxCNTH:TPMxCNTL counter is $0000. (The new duty cycle does not take effect until the next full period.)

10.5.3 Center-Aligned PWM Mode

This type of PWM output uses the up-/down-counting mode of the timer counter (CPWMS = 1). The output compare value in TPMxCnVH:TPMxCnVL determines the pulse width (duty cycle) of the PWM signal and the period is determined by the value in TPMxMODH:TPMxMODL. TPMxMODH:TPMxMODL should be kept in the range of $0001 to $7FFF because values outside this range can produce ambiguous results. ELSnA will determine the polarity of the CPWM output.

$$\text{pulse width} = 2 \times (\text{TPMxCnVH:TPMxCnVL}) \qquad \textit{Eqn. 10-1}$$

$$\text{period} = 2 \times (\text{TPMxMODH:TPMxMODL}); \quad \text{for TPMxMODH:TPMxMODL} = \$0001\text{–}\$7FFF \qquad \textit{Eqn. 10-2}$$

If the channel value register TPMxCnVH:TPMxCnVL is zero or negative (bit 15 set), the duty cycle will be 0 percent. If TPMxCnVH:TPMxCnVL is a positive value (bit 15 clear) and is greater than the (nonzero) modulus setting, the duty cycle will be 100 percent because the duty cycle compare will never occur. This implies the usable range of periods set by the modulus register is $0001 through $7FFE ($7FFF if

10.6.4 PWM End-of-Duty-Cycle Events

For channels that are configured for PWM operation, there are two possibilities:

- When the channel is configured for edge-aligned PWM, the channel flag is set when the timer counter matches the channel value register that marks the end of the active duty cycle period.
- When the channel is configured for center-aligned PWM, the timer count matches the channel value register twice during each PWM cycle. In this CPWM case, the channel flag is set at the start and at the end of the active duty cycle, which are the times when the timer counter matches the channel value register.

The flag is cleared by the 2-step sequence described in Section 10.6.1, "Clearing Timer Interrupt Flags."

10.7 TPM Registers and Control Bits

The TPM includes:

- An 8-bit status and control register (TPMxSC)
- A 16-bit counter (TPMxCNTH:TPMxCNTL)
- A 16-bit modulo register (TPMxMODH:TPMxMODL)

Each timer channel has:

- An 8-bit status and control register (TPMxCnSC)
- A 16-bit channel value register (TPMxCnVH:TPMxCnVL)

Refer to the direct-page register summary in the Memory chapter of this data sheet for the absolute address assignments for all TPM registers. This section refers to registers and control bits only by their names. A Freescale-provided equate or header file is used to translate these names into the appropriate absolute addresses.

Some MCU systems have more than one TPM, so register names include placeholder characters to identify which TPM and which channel is being referenced. For example, TPMxCnSC refers to timer (TPM) x, channel n and TPM1C2SC is the status and control register for timer 1, channel 2.

Table 10-5. Mode, Edge, and Level Selection

CPWMS	MSnB:MSnA	ELSnB:ELSnA	Mode	Configuration
X	XX	00	Pin not used for TPM channel; use as an external clock for the TPM or revert to general-purpose I/O	
0	00	01	Input capture	Capture on rising edge only
		10		Capture on falling edge only
		11		Capture on rising or falling edge
	01	00	Output compare	Software compare only
		01		Toggle output on compare
		10		Clear output on compare
		11		Set output on compare
	1X	10	Edge-aligned PWM	High-true pulses (clear output on compare)
		X1		Low-true pulses (set output on compare)
1	XX	10	Center-aligned PWM	High-true pulses (clear output on compare-up)
		X1		Low-true pulses (set output on compare-up)

If the associated port pin is not stable for at least two bus clock cycles before changing to input capture mode, it is possible to get an unexpected indication of an edge trigger. Typically, a program would clear status flags after changing channel configuration bits and before enabling channel interrupts or using the status flags to avoid any unexpected behavior.

10.7.5 Timer x Channel Value Registers (TPMxCnVH:TPMxCnVL)

These read/write registers contain the captured TPM counter value of the input capture function or the output compare value for the output compare or PWM functions. The channel value registers are cleared by reset.

	7	6	5	4	3	2	1	0
R W	Bit 15	14	13	12	11	10	9	Bit 8
Reset	0	0	0	0	0	0	0	0

Figure 10-11. Timer x Channel Value Register High (TPMxCnVH)

	7	6	5	4	3	2	1	0
R W	Bit 7	6	5	4	3	2	1	Bit 0
Reset	0	0	0	0	0	0	0	0

Figure 10-12. Timer Channel Value Register Low (TPMxCnVL)

11.1.1 Features

Features of SCI module include:

- Full-duplex, standard non-return-to-zero (NRZ) format
- Double-buffered transmitter and receiver with separate enables
- Programmable baud rates (13-bit modulo divider)
- Interrupt-driven or polled operation:
  - — Transmit data register empty and transmission complete
  - — Receive data register full
  - — Receive overrun, parity error, framing error, and noise error
  - — Idle receiver detect
- Hardware parity generation and checking
- Programmable 8-bit or 9-bit character length
- Receiver wakeup by idle-line or address-mark

11.1.2 Modes of Operation

See Section 11.3, "Functional Description," for a detailed description of SCI operation in the different modes.

- 8- and 9- bit data modes
- Stop modes — SCI is halted during all stop modes
- Loop modes

11.2.5 SCI Status Register 2 (SCIxS2)

This register has one read-only status flag. Writes have no effect.

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	RAF
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 11-9. SCI Status Register 2 (SCIxS2)

Table 11-6. SCIxS2 Register Field Descriptions

Field	Description
0 RAF	**Receiver Active Flag** — RAF is set when the SCI receiver detects the beginning of a valid start bit, and RAF is cleared automatically when the receiver detects an idle line. This status flag can be used to check whether an SCI character is being received before instructing the MCU to go to stop mode. 0 SCI receiver idle waiting for a start bit. 1 SCI receiver active (RxD input not idle).

11.2.6 SCI Control Register 3 (SCIxC3)

	7	6	5	4	3	2	1	0
R	R8	T8	TXDIR	0	ORIE	NEIE	FEIE	PEIE
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 11-10. SCI Control Register 3 (SCIxC3)

Table 11-7. SCIxC3 Register Field Descriptions

Field	Description
7 R8	**Ninth Data Bit for Receiver** — When the SCI is configured for 9-bit data (M = 1), R8 can be thought of as a ninth receive data bit to the left of the MSB of the buffered data in the SCIxD register. When reading 9-bit data, read R8 before reading SCIxD because reading SCIxD completes automatic flag clearing sequences which could allow R8 and SCIxD to be overwritten with new data.
6 T8	**Ninth Data Bit for Transmitter** — When the SCI is configured for 9-bit data (M = 1), T8 may be thought of as a ninth transmit data bit to the left of the MSB of the data in the SCIxD register. When writing 9-bit data, the entire 9-bit value is transferred to the SCI shift register after SCIxD is written so T8 should be written (if it needs to change from its previous value) before SCIxD is written. If T8 does not need to change in the new value (such as when it is used to generate mark or space parity), it need not be written each time SCIxD is written.
5 TXDIR	**TxD Pin Direction in Single-Wire Mode** — When the SCI is configured for single-wire half-duplex operation (LOOPS = RSRC = 1), this bit determines the direction of data at the TxD pin. 0 TxD pin is an input in single-wire mode. 1 TxD pin is an output in single-wire mode.

15.2.3 BDC Commands

BDC commands are sent serially from a host computer to the BKGD pin of the target HCS08 MCU. All commands and data are sent MSB-first using a custom BDC communications protocol. Active background mode commands require that the target MCU is currently in the active background mode while non-intrusive commands may be issued at any time whether the target MCU is in active background mode or running a user application program.

Table 15-1 shows all HCS08 BDC commands, a shorthand description of their coding structure, and the meaning of each command.

Coding Structure Nomenclature

This nomenclature is used in Table 15-1 to describe the coding structure of the BDC commands.

		Commands begin with an 8-bit hexadecimal command code in the host-to-target direction (most significant bit first)
/	=	separates parts of the command
d	=	delay 16 target BDC clock cycles
AAAA	=	a 16-bit address in the host-to-target direction
RD	=	8 bits of read data in the target-to-host direction
WD	=	8 bits of write data in the host-to-target direction
RD16	=	16 bits of read data in the target-to-host direction
WD16	=	16 bits of write data in the host-to-target direction
SS	=	the contents of BDCSCR in the target-to-host direction (STATUS)
CC	=	8 bits of write data for BDCSCR in the host-to-target direction (CONTROL)
RBKP	=	16 bits of read data in the target-to-host direction (from BDCBKPT breakpoint register)
WBKP	=	16 bits of write data in the host-to-target direction (for BDCBKPT breakpoint register)

15.4.3.5 Debug FIFO High Register (DBGFH)

This register provides read-only access to the high-order eight bits of the FIFO. Writes to this register have no meaning or effect. In the event-only trigger modes, the FIFO only stores data into the low-order byte of each FIFO word, so this register is not used and will read 0x00.

Reading DBGFH does not cause the FIFO to shift to the next word. When reading 16-bit words out of the FIFO, read DBGFH before reading DBGFL because reading DBGFL causes the FIFO to advance to the next word of information.

15.4.3.6 Debug FIFO Low Register (DBGFL)

This register provides read-only access to the low-order eight bits of the FIFO. Writes to this register have no meaning or effect.

Reading DBGFL causes the FIFO to shift to the next available word of information. When the debug module is operating in event-only modes, only 8-bit data is stored into the FIFO (high-order half of each FIFO word is unused). When reading 8-bit words out of the FIFO, simply read DBGFL repeatedly to get successive bytes of data from the FIFO. It isn't necessary to read DBGFH in this case.

Do not attempt to read data from the FIFO while it is still armed (after arming but before the FIFO is filled or ARMF is cleared) because the FIFO is prevented from advancing during reads of DBGFL. This can interfere with normal sequencing of reads from the FIFO.

Reading DBGFL while the debugger is not armed causes the address of the most-recently fetched opcode to be stored to the last location in the FIFO. By reading DBGFH then DBGFL periodically, external host software can develop a profile of program execution. After eight reads from the FIFO, the ninth read will return the information that was stored as a result of the first read. To use the profiling feature, read the FIFO eight times without using the data to prime the sequence and then begin using the data to get a delayed picture of what addresses were being executed. The information stored into the FIFO on reads of DBGFL (while the FIFO is not armed) is the address of the most-recently fetched opcode.

A.9.1 Control Timing

Table A-10. Control Timing

Parameter	Symbol	Min	Typical	Max	Unit
Bus frequency ($t_{cyc} = 1/f_{Bus}$)	f_{Bus}	dc	—	20	MHz
Real-time interrupt internal oscillator period	t_{RTI}	700		1300	μs
External reset pulse width[1]	t_{extrst}	1.5 x f_{Self_reset}		—	ns
Reset low drive[2]	t_{rstdrv}	34 x f_{Self_reset}		—	ns
Active background debug mode latch setup time	t_{MSSU}	25		—	ns
Active background debug mode latch hold time	t_{MSH}	25		—	ns
IRQ pulse width[3]	t_{ILIH}	1.5 x t_{cyc}		—	ns
Port rise and fall time (load = 50 pF)[4] Slew rate control disabled Slew rate control enabled	t_{Rise}, t_{Fall}	 — —	 3 30		ns

1 This is the shortest pulse that is guaranteed to be recognized as a reset pin request. Shorter pulses are not guaranteed to override reset requests from internal sources.

2 When any reset is initiated, internal circuitry drives the reset pin low for about 34 cycles of f_{Self_reset} and then samples the level on the reset pin about 38 cycles later to distinguish external reset requests from internal requests.

3 This is the minimum pulse width that is guaranteed to pass through the pin synchronization circuitry. Shorter pulses may or may not be recognized. In stop mode, the synchronizer is bypassed so shorter pulses can be recognized in that case.

4 Timing is shown with respect to 20% V_{DD} and 80% V_{DD} levels. Temperature range –40°C to 85°C.

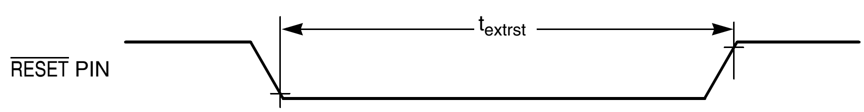


Figure A-11. Reset Timing

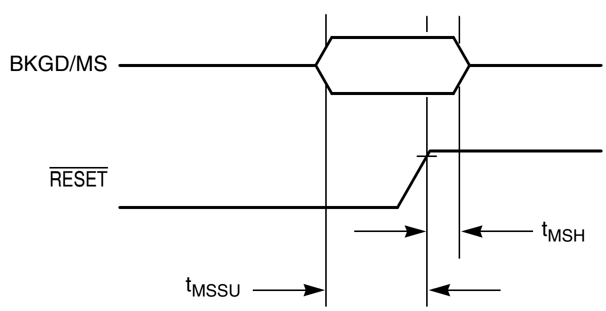


Figure A-12. Active Background Debug Mode Latch Timing